Complementary Bias Resistor Transistors R1 = 10 k\Omega, R2 = 10 k\Omega NPN and PNP Transistors with Monolithic Bias Resistor Network

This series of digital transistors is designed to replace a single device and its external resistor bias network. The Bias Resistor Transistor (BRT) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base-emitter resistor. The BRT eliminates these individual components by integrating them into a single device. The use of a BRT can reduce both system cost and board space.

Features

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable*
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

 $(T_A = 25^{\circ}C \text{ both polarities } Q_1 (PNP) \& Q_2 (NPN), unless otherwise noted)$

| Rating | Symbol | Max | Unit |
|--------------------------------|----------------------|-----|------|
| Collector-Base Voltage | V _{CBO} | 50 | Vdc |
| Collector-Emitter Voltage | V _{CEO} | 50 | Vdc |
| Collector Current – Continuous | Ι _C | 100 | mAdc |
| Input Forward Voltage | V _{IN(fwd)} | 40 | Vdc |
| Input Reverse Voltage | V _{IN(rev)} | 10 | Vdc |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ORDERING INFORMATION

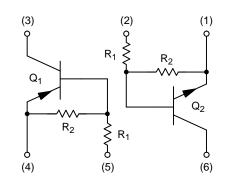
| Device | Package | Shipping [†] |
|---|---------|-----------------------|
| MUN5311DW1T1G, SMUN5311DW1T1G* | SOT-363 | 3,000/Tape & Reel |
| MUN5311DW1T2G, SMUN5311DW1T2G* | SOT-363 | 3,000/Tape & Reel |
| SMUN5311DW1T3G | SOT-363 | 10,000/Tape & Reel |
| NSBC114EPDXV6T1G, NSVBC114EPDXV6T1G* | SOT-563 | 4,000/Tape & Reel |



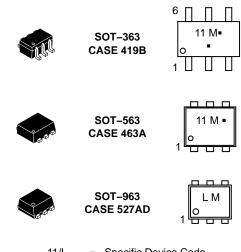
ON Semiconductor®

www.onsemi.com

PIN CONNECTIONS



MARKING DIAGRAMS





(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

Semiconductor Components Industries, LLC, 2014 July, 2018 – Rev. 4

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|------------------|---------|-----------------------|
| NSBC114EPDXV6T5G | SOT-563 | 8,000/Tape & Reel |
| NSBC114EPDP6T5G | SOT-963 | 8,000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

| | Characteristic | Symbol | Max | Unit |
|---|-------------------------------|-----------------------------------|--------------------------|-------------|
| MUN5311DW1 (SOT-363) ON | E JUNCTION HEATED | | | |
| Total Device Dissipation $T_A = 25^{\circ}C$ (Note 1) (Note 2) Derate above 25^{C} (Note 2) | (Note 1) | PD | 187 256 1.5 2.0 | mW mW/°C |
| Thermal Resistance, Junction to Ambient | (Note 1) (Note 2) | R _{θJA} | 670 490 | °C/W |
| MUN5311DW1 (SOT-363) BC | TH JUNCTION HEATED (Note 3) | | | |
| Total Device Dissipation $T_A = 25^{\circ}C$ (Note 1) (Note 2) Derate above 25^{C} (Note 2) | (Note 1) | PD | 250 385 2.0 3.0 | mW mW/°C |
| Thermal Resistance, Junction to Ambient (Note 2) | (Note 1) | R _{0JA} | 493 325 | °C/W |
| Thermal Resistance, Junction to Lead (Note 1) (Note 2) | | R _{θJL} | 188 208 | °C/W |
| Junction and Storage Temper | ature Range | T _J , T _{stg} | -55 to +150 | °C |
| NSBC114EPDXV6 (SOT-563) | ONE JUNCTION HEATED | | · · · · · | |
| $\begin{array}{l} \mbox{Total Device Dissipation} \\ T_A = 25^\circ C \qquad (Note 1) \\ \mbox{Derate above } 25^\circ C \end{array}$ | (Note 1) | PD | 357 2.9 | mW mW/°C |
| Thermal Resistance, Junction to Ambient | (Note 1) | R _{0JA} | 350 | °C/W |
| NSBC114EPDXV6 (SOT-563) | BOTH JUNCTION HEATED (Note 3) | | | |
| $\begin{array}{l} \mbox{Total Device Dissipation} \\ T_A = 25^\circ C \qquad (Note 1) \\ \mbox{Derate above } 25^\circ C \end{array}$ | (Note 1) | P _D | 500 4.0 | mW mW/°C |
| Thermal Resistance, Junction to Ambient | (Note 1) | R _{θJA} | 250 | °C/W |
| Junction and Storage Temper | ature Range | T _J , T _{stg} | -55 to +150 | °C |
| NSBC114EPDP6 (SOT-963) | ONE JUNCTION HEATED | | | |
| Total Device Dissipation $T_A = 25^{\circ}C$ (Note 4) (Note 5) Derate above 25^{\circ}C (Note 5) | (Note 4) | PD | 231 269 1.9 2.2 | MW mW/°C |
| Thermal Resistance, Junction to Ambient (Note 5) | (Note 4) | R _{θJA} | 540 464 | °C/W |
| NSBC114EPDP6 (SOT-963) | BOTH JUNCTION HEATED (Note 3) | | | |
| $\begin{array}{l} \mbox{Total Device Dissipation} \\ T_A = 25^\circ C \qquad (Note 4) \\ (Note 5) \\ \mbox{Derate above } 25^\circ C \\ (Note 5) \end{array}$ | (Note 4) | PD | 339 408 2.7 3.3 | MW mW/°C |

THERMAL CHARACTERISTICS

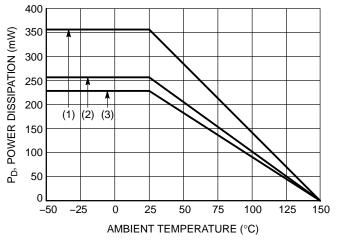
| Characteristic | Symbol | Max | Unit |
|---|-----------------------------------|-------------|------|
| NSBC114EPDP6 (SOT-963) BOTH JUNCTION HEATED (Note 3) | | | |
| Thermal Resistance, Junction to Ambient (Note 4) (Note 5) | $R_{	heta JA}$ | 369 306 | °C/W |
| Junction and Storage Temperature Range | T _J , T _{stg} | -55 to +150 | °C |

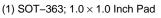
FR-4 @ Minimum Pad.
FR-4 @ 1.0 × 1.0 Inch Pad.
Both junction heated values assume total power is sum of two equally powered channels.
FR-4 @ 100 mm², 1 oz. copper traces, still air.
FR-4 @ 500 mm², 1 oz. copper traces, still air.

| ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ both polarities Q_1 (PNP) & Q_2 (NPN), unless otherwise noted) | |
|--|--|
|--|--|

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|--------------------------------|-----|------------|------|------|
| OFF CHARACTERISTICS | | | | | |
| Collector-Base Cutoff Current ($V_{CB} = 50 \text{ V}, I_E = 0$) | I _{CBO} | _ | _ | 100 | nAdc |
| Collector-Emitter Cutoff Current $(V_{CE} = 50 \text{ V}, I_B = 0)$ | I _{CEO} | _ | _ | 500 | nAdc |
| Emitter-Base Cutoff Current ($V_{EB} = 6.0 \text{ V}, I_C = 0$) | I _{EBO} | - | - | 0.5 | mAdc |
| Collector-Base Breakdown Voltage $(I_C = 10 \ \mu A, I_E = 0)$ | V _{(BR)CBO} | 50 | - | - | Vdc |
| Collector-Emitter Breakdown Voltage (Note 6) $(I_C = 2.0 \text{ mA}, I_B = 0)$ | V _{(BR)CEO} | 50 | _ | _ | Vdc |
| ON CHARACTERISTICS | | | | | |
| DC Current Gain (Note 6) ($I_C = 5.0 \text{ mA}, V_{CE} = 10 \text{ V}$) | h _{FE} | 35 | 60 | _ | |
| Collector-Emitter Saturation Voltage (Note 6) ($I_C = 10 \text{ mA}, I_B = 0.3 \text{ mA}$) | V _{CE(sat)} | _ | _ | 0.25 | V |
| Input Voltage (Off) ($V_{CE} = 5.0 \text{ V}, I_C = 100 \mu\text{A}$) (NPN) ($V_{CE} = 5.0 \text{ V}, I_C = 100 \mu\text{A}$) (PNP) | V _{i(off)} | - | 1.2 1.2 | | Vdc |
| Input Voltage (On) ($V_{CE} = 0.2 \text{ V}, I_C = 10 \text{ mA}$) (NPN) ($V_{CE} = 0.2 \text{ V}, I_C = 10 \text{ mA}$) (PNP) | V _{i(on)} | - | 2.0 2.2 | | Vdc |
| Output Voltage (On) ($V_{CC} = 5.0 \text{ V}, \text{ V}_B = 2.5 \text{ V}, \text{ R}_L = 1.0 \text{ k}\Omega$) | V _{OL} | - | - | 0.2 | Vdc |
| Output Voltage (Off) $(V_{CC} = 5.0 \text{ V}, \text{ V}_{B} = 0.5 \text{ V}, \text{ R}_{L} = 1.0 \text{ k}\Omega)$ | V _{OH} | 4.9 | _ | _ | Vdc |
| Input Resistor | R1 | 7.0 | 10 | 13 | kΩ |
| Resistor Ratio | R ₁ /R ₂ | 0.8 | 1.0 | 1.2 | |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 6. Pulsed Condition: Pulse Width = 300 ms, Duty Cycle $\leq 2\%$.

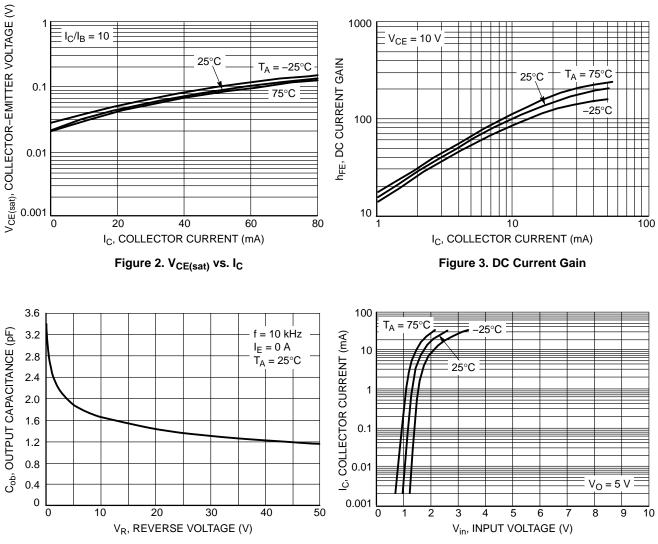




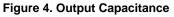
(2) SOT-563; Minimum Pad

(3) SOT-963; 100 mm², 1 oz. Copper Trace

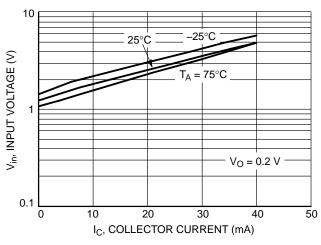
Figure 1. Derating Curve



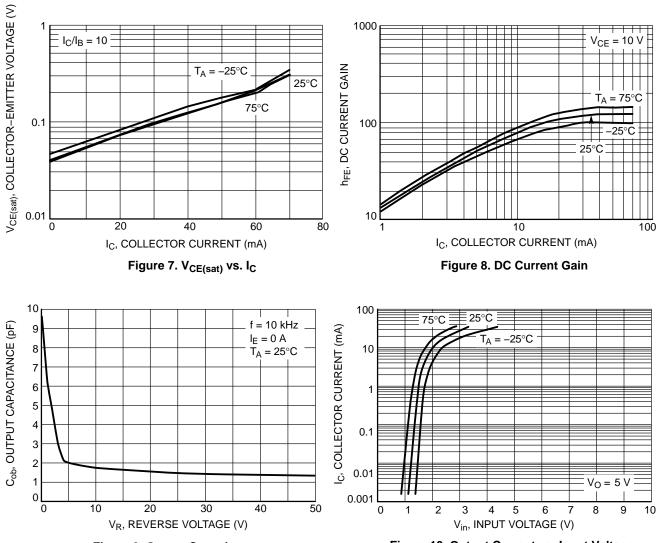
TYPICAL CHARACTERISTICS – NPN TRANSISTOR MUN5311DW1, NSBC114EPDXV6



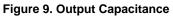




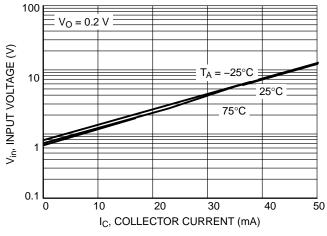




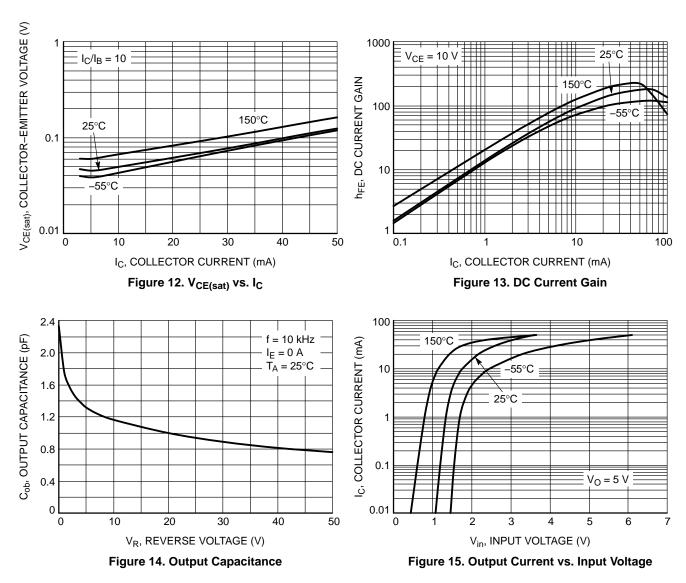
TYPICAL CHARACTERISTICS – PNP TRANSISTOR MUN5311DW1, NSBC114EPDXV6



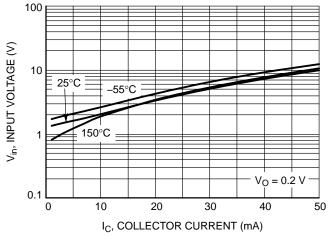




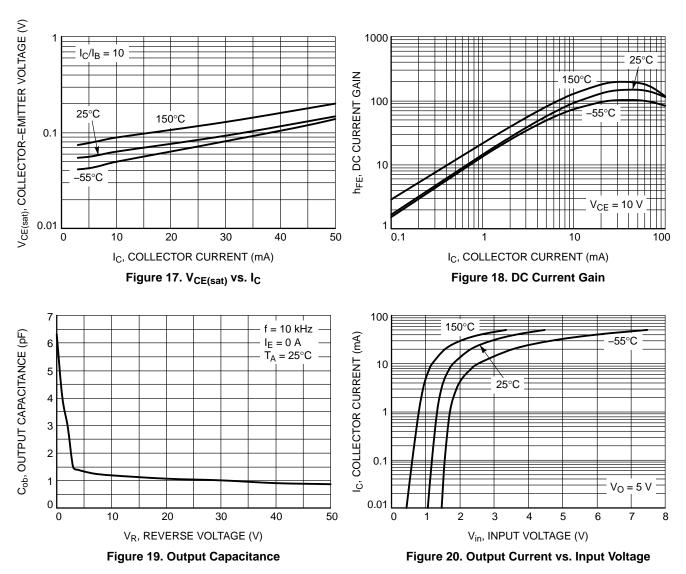




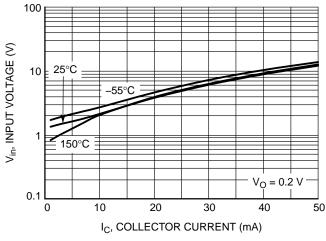
TYPICAL CHARACTERISTICS – NPN TRANSISTOR NSBC114EPDP6







TYPICAL CHARACTERISTICS – PNP TRANSISTOR NSBC114EPDP6





0.043

0.004





- XXX = Specific Device Code

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering

details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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SC-88/SC70-6/SOT-363 CASE 419B-02 ISSUE Y

DATE 11 DEC 2012

| STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2 | STYLE 2: CANCELLED | STYLE 3: CANCELLED | STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE | STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE | STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2 |
|--|-----------------------|--|---|---|---|
| STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2 | STYLE 8: CANCELLED | STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2 | STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2 | STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2 | STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2 |
| STYLE 13: | STYLE 14: | STYLE 15: | STYLE 16: | STYLE 17: | STYLE 18: |
| PIN 1. ANODE | PIN 1. VREF | PIN 1. ANODE 1 | PIN 1. BASE 1 | PIN 1. BASE 1 | PIN 1. VIN1 |
| 2. N/C | 2. GND | 2. ANODE 2 | 2. EMITTER 2 | 2. EMITTER 1 | 2. VCC |
| 3. COLLECTOR | 3. GND | 3. ANODE 3 | 3. COLLECTOR 2 | 3. COLLECTOR 2 | 3. VOUT2 |
| 4. EMITTER | 4. IOUT | 4. CATHODE 3 | 4. BASE 2 | 4. BASE 2 | 4. VIN2 |
| 5. BASE | 5. VEN | 5. CATHODE 2 | 5. EMITTER 1 | 5. EMITTER 2 | 5. GND |
| 6. CATHODE | 6. VCC | 6. CATHODE 1 | 6. COLLECTOR 1 | 6. COLLECTOR 1 | 6. VOUT1 |
| STYLE 19: | STYLE 20: | STYLE 21: | STYLE 22: | STYLE 23: | STYLE 24: |
| PIN 1. I OUT | PIN 1. COLLECTOR | PIN 1. ANODE 1 | PIN 1. D1 (i) | PIN 1. Vn | PIN 1. CATHODE |
| 2. GND | 2. COLLECTOR | 2. N/C | 2. GND | 2. CH1 | 2. ANODE |
| 3. GND | 3. BASE | 3. ANODE 2 | 3. D2 (i) | 3. Vp | 3. CATHODE |
| 4. V CC | 4. EMITTER | 4. CATHODE 2 | 4. D2 (c) | 4. N/C | 4. CATHODE |
| 5. V EN | 5. COLLECTOR | 5. N/C | 5. VBUS | 5. CH2 | 5. CATHODE |
| 6. V REF | 6. COLLECTOR | 6. CATHODE 1 | 6. D1 (c) | 6. N/C | 6. CATHODE |
| STYLE 25: | STYLE 26: | STYLE 27: | STYLE 28: | STYLE 29: | STYLE 30: |
| PIN 1. BASE 1 | PIN 1. SOURCE 1 | PIN 1. BASE 2 | PIN 1. DRAIN | PIN 1. ANODE | PIN 1. SOURCE 1 |
| 2. CATHODE | 2. GATE 1 | 2. BASE 1 | 2. DRAIN | 2. ANODE | 2. DRAIN 2 |
| 3. COLLECTOR 2 | 3. DRAIN 2 | 3. COLLECTOR 1 | 3. GATE | 3. COLLECTOR | 3. DRAIN 2 |
| 4. BASE 2 | 4. SOURCE 2 | 4. EMITTER 1 | 4. SOURCE | 4. EMITTER | 4. SOURCE 2 |
| 5. EMITTER | 5. GATE 2 | 5. EMITTER 2 | 5. DRAIN | 5. BASE/ANODE | 5. GATE 1 |
| 6. COLLECTOR 1 | 6. DRAIN 1 | 6. COLLECTOR 2 | 6. DRAIN | 6. CATHODE | 6. DRAIN 1 |

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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6Х

(

MILLIMETERS

NDM.

0.55

0.22

0.13

1.60

1.20

0.50 BSC

0.20

1.60

MAX.

0.60

0.27

0.18

1.70

1.30

0.30

1.70

SIDE VIEW

MIN.

0.50

0.17

0.08

1.50

1.10

0.10

1.50

DIM

Α

b

С

D E

e L

 H_E



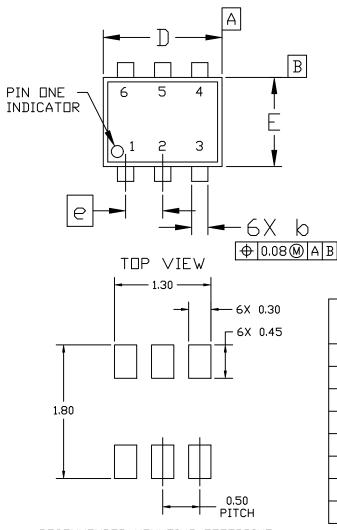


SOT-563, 6 LEAD CASE 463A ISSUE H

DATE 26 JAN 2021

ALE 4:1

- NDTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 1. DIMENSIONING AND TOLERANCING PER A 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS DF BASE MATERIAL.



RECOMMENDED MOUNTING FOOTPRINT* * For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

| | SOT-563, 6 LEAD | | PAGE 1 OF 2 |
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| STYLE 1: | STYLE 2: | STYLE 3: |
|---|---|------------------|
| PIN 1. EMITTER 1 | PIN 1. EMITTER 1 | PIN 1. CATHIDE 1 |
| 2. BASE 1 | 2. EMITTER 2 | 2. CATHIDE 1 |
| 3. COLLECTOR 2 | 3. BASE 2 | 3. ANUDE/ANUDE 2 |
| 4. EMITTER 2 | 4. COLLECTOR 2 | 4. CATHIDE 2 |
| 5. BASE 2 | 5. BASE 1 | 5. CATHIDE 2 |
| 6. COLLECTOR 1 | 6. COLLECTOR 1 | 6. ANUDE/ANUDE 1 |
| STYLE 4: | STYLE 5: | STYLE 6: |
| PIN 1. COLLECTOR | PIN 1. CATHODE | PIN 1. CATHODE |
| 2. COLLECTOR | 2. CATHODE | 2. ANODE |
| 3. BASE | 3. ANODE | 3. CATHODE |
| 4. EMITTER | 4. ANODE | 4. CATHODE |
| 5. COLLECTOR | 5. CATHODE | 5. CATHODE |
| 6. COLLECTOR | 6. CATHODE | 6. CATHODE |
| STYLE 7: | STYLE 8: | STYLE 9: |
| PIN 1. CATHODE | PIN 1. DRAIN | PIN 1. SDURCE 1 |
| 2. ANODE | 2. DRAIN | 2. GATE 1 |
| 3. CATHODE | 3. GATE | 3. DRAIN 2 |
| 4. CATHODE | 4. SDURCE | 4. SDURCE 2 |
| 5. ANODE | 5. DRAIN | 5. GATE 2 |
| 6. CATHODE | 6. DRAIN | 6. DRAIN 1 |
| STYLE 10: PIN 1. CATHODE 1 2. N/C 3. CATHODE 2 4. ANODE 2 5. N/C 6. ANODE 1 | STYLE 11: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2 | |

6. COLLECTOR 2

DATE 26 JAN 2021

GENERIC **MARKING DIAGRAM***

XX M=

XX = Specific Device Code

M = Month Code

. = Pb-Free Package

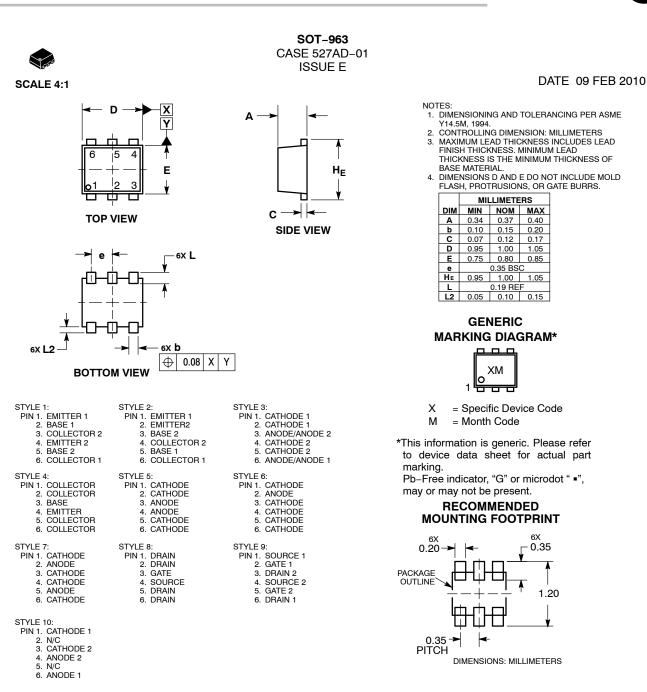
*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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| | | | | |

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4. ANDDE 2 5. N/C 6. ANDDE 1





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